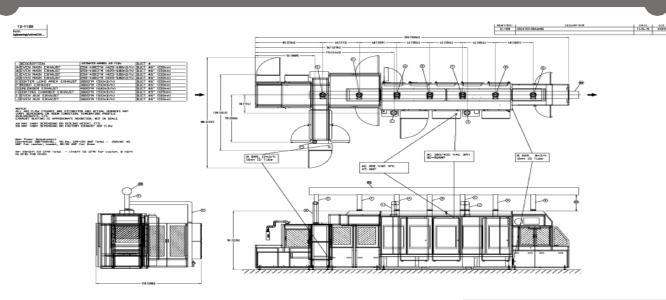
DP9000 SYSTEM



Drawing Draw Sale Tak or United Nation Distances Revision

SPECIFICATIONS	DP9000 V1	DDOOOD
Minimum Panel Dimension (width X height)	305 X 305mm (12" X 12")	DP9000
Maximum Panel Dimension (width X height)	610 X 762mm (24" X 30") w/extend clamp 610 X 686mm	System
Minimum Thickness	0.4mm (0.016") * (Dependent on panel construction)	
Maximum Thickness	3mm (0.120")	Please refer to
Border Requirement	8mm (.375")	DP6000 FL
Screen Frame Size (width X Height X thickness)	934 X 1361 X 38mm (37" X 53.6" a.5")	DP6000 ML
Printing Speed	Step less adjustable 2.5 - 25 cm/sec	DP6000 V2
Flood Speed	Step less adjustable 2.5 - 25 cm/sec	
Maximum Machine Cycles	125pph** Both Sides Coated Simultaneously	Specific data
Electrical	380-400V 3Ø 125 Amp 50Hz / 208-240 1Ø 10 Amp 50Hz	sheets for
	480V 3Ø 125 Amp 60 Hz / 208-240 1Ø 10 Amp 60Hz	more
Pneumatic	25m ³ /hr. @ 6 bar (15cfm @ 90 psi) recommended	information
Length	940 cm (370")	and
Maximum Width	333 cm (131")	specifications
Height	256 cm (101")	for these
Height Pass Height	902 -940mm (35.3 - 40.5")	variant
Exhaust System	2500m ³ /hr. (1500cfm)	models.
Weight Coater Module	2360 kg (5200 lbs.)	
Oven Module	3150 kg (6900 lbs.)	
Crated Dimensions System	45' high cube container	
** Represents mechanical capability based on 610mr Actual production rate may vary.	n (height) panel in FPP mode.	

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TAIYO CIRCUIT AUTOMATION **GLOBAL LEADER IN LPI COATING**







FU LY AUTOMATIC DP9000 SYSTEM



The shrinking of PCB structure, conductor width and drilling hole diameter, has brought to develop the integration of the via holes with the surface soldermask outer layer feature of HDI designs. Current soldermask masking technologies have to evolved mirroring more challenging designs combining high copper circuits, higher layer counts and smaller drilled holes, filled vias and built-up multilayers. Solder masking requires thinner, controllable, consistent,

repeatable, superior trace

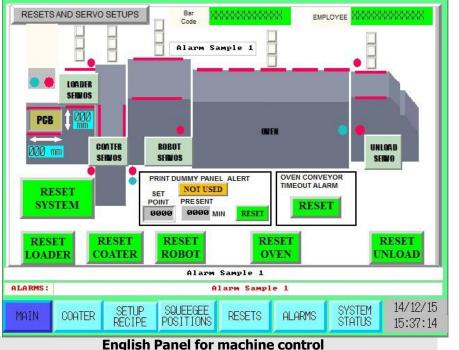
encapsulation and more consistent, predictable overall coverage. Contamination such as flux residues, fibers, and debris enhance the adsorption of moisture and leads to failures and surface defects.

TaiyoCircuitAutomation has responded, introducing the **DP9000** Cleanliness in both room environment and in application equipment is now a critical component requirement for the application of LPI soldermask lacquer due to the shrinking geometry between components and increased density.

Advanced technology requires a **cleanroom** with a low level of environmental pollutants such as dust, aerosol particles, and chemical vapors. To meet

these new requirements, The **DP9000** was developed as a new series of equipment with

improved capacities while contributing less room contamination.



Incorporated into the **DP9000** is a sophisticated, PLC to control the entire machine which is integrated with a PC designed to Data Log all the critical machine functions and settings.

System controls and logging system supports several languages including English, Chinese, French & German.



the thickest backpanels. through "Smart Print System" released, modulation of the selected squeegee pressure during the printing cycles. Varying the squeegee force stabilizes the Dynamic Squeegee Pressure across the substrate during coating, improving coverage and reducing mask in holes.

Recipe controlled fourth servo axis synchronizes peel off frame opening sequence and Dynamic Squeegee Pressure applied to the substrate work surface. This system is unique in its ability to modulate and sustain uniform Dynamic Printing Pressure.



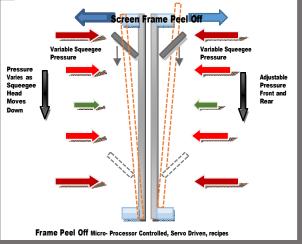
Data Logging PC

DP9000 commercialized many new innovations. Continuous improvement always starts by observing previous results and building from the past. Improved squeegee print heads that

deliver more dynamic squeegee pressure to the point of mask transfer. These heads are more capable resulting in a wider range of Smart Print capabilities.

Refined and improved LPI coater featuring the SPS "Smart Print System". Precise control with recipe functions reduces coating variation across the panel from the top to bottom and front to rear. **DP9000** has enhanced process stratagems; precisely and reliably coating the finest micro-thin flexible substrates

Newly permits



Smart Print Diagram



DP9000 liquid photoimageable coating machines by now capturing critical data concerning each panel that is coated with the machine. With this now standard feature, the PLC captures the critical setup and operation data. The files are then automatically transferred to a PC in the .xls format via proprietary CAI software. The .XLS or. C format is then easily manipulated by an Excel spread sheet to allow custom printing of the data as desired or loaded into other customer databased systems.